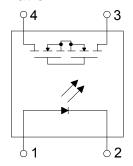
4PIN 100V N.O TYPE SOLID STATE RELAY-MOSFET OUTPUT

Description

The KCP1008 series is robust, ideal for telecom and ground fault applications. It is a SPST normally open switch (1 Form A) that replaces electromechanical relays in many applications. It is constructed using a GaAlAs LED for actuation control and an integrated monolithic die for the switch output. The die is fabricated in a high-voltage dielectrically isolated technology and is comprised of a photodiode array, switch control circuitry and MOSFET switches.

Schematic



1 FORM A NORMALLY OPEN



Features

- 1. Normally open, single pole single throw
- 2. Control 100V AC or DC voltage
- 3. Switch 150mA loads
- 4. Controls low-level analog signals
- 5. High sensitivity, low ON resistance
- 6. Low-level off-state leakage current
- 7. High isolation voltage
- 8. Pb free and RoHS compliant
- 9. MSL class 1
- 10. Agency Approvals:
 - UL Approved (No. E108430): UL508
 - c-UL Approved (No. E108430)
 - FIMKO Approved: EN60065, EN60950

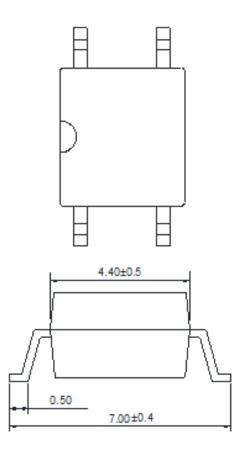
Applications

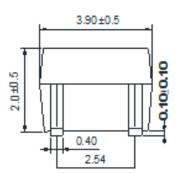
- Telecommunications (PC, electronic notepad)
- Modem
- Telephone equipment
- Security equipment
- Sensors
- · Measuring and testing equipment
- Factory automation equipment
- · High speed inspection machines

4PIN 100V N.O TYPE SOLID STATE RELAY-MOSFET OUTPUT

Outside Dimension

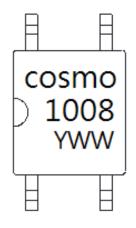
Unit: mm





TOLERANCE: ±0.2mm

Device Marking



Notes:

cosmo

1008

YWW Y: Year code / W: Week code

4PIN 100V N.O TYPE SOLID STATE RELAY-MOSFET OUTPUT

Absolute Maximum Ratings

(Ta=25°C)

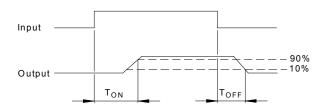
Item		Symbol	Rating	Unit
Input	Continuous forward current	I _F	50	mA
	Peak forward current	I _{FP}	1	А
	Reverse voltage	V_R	5	V
	Power dissipation	P _{in}	100	mW
	Derate linearly from 25°C	-	1.3	mW/°C
	Breakdown voltage	V _B	100	V
Output	Continuous load current	ΙL	150	mA
	Power dissipation	P _{out}	500	mW
Isolation voltage		V _{iso}	1500	Vrms
Isolation resistance (Vio=500V)		R _{iso}	≥10 ¹⁰	Ω
Total power dissipation		Pt	550	mW
Derate linearly from 25°C		-	2.5	mW/°C
Operating temperature		T _{opr}	-40 to +85	$^{\circ}\!\mathbb{C}$
Storage temperature		T _{stg}	-40 to +125	$^{\circ}\!\mathbb{C}$
Junction temperature		Tj	100	$^{\circ}\!\mathbb{C}$
Soldering temperature 10 seconds		T _{sol}	260	$^{\circ}\!\mathbb{C}$

Electro-optical Characteristics

(Ta=25°C)

Parameter		Symbol	Conditions	Min.	Тур.	Max.	Unit
Input	Forward voltage	V _F	I _F =10mA	-	1.2	1.5	V
	Operation input current	I _{FON}	V _L =20V, I _L =100mA	-	-	2.0	mA
	Recovery input current	I _{FOFF}	V _L =20V, I _L ≦5μA	0.2	-	-	mA
Output	Breakdown voltage	V_B	I _B =50μA	100	-	-	V
	Off-state leakage current	I _{LEAK}	V _L =100V, I _F =0mA	-	0.2	1.0	μΑ
I/O capacitance		C _{iso}	V _B =0V, f=1MHz	-	6	-	pF
ON resistance		R _{ON}	I _F =10mA, I _L =100mA	-	6	8	Ω
Turn-on time		T _{ON}	I _F =10mA, V _L =20V	-	0.3	2.0	ms
Turn-off time		T _{OFF}	I _L =100mA, t=10ms	-	0.1	1.0	ms

• Turn-on / Turn-off Time





4PIN 100V N.O TYPE SOLID STATE RELAY-MOSFET OUTPUT

Schematic and Wiring Diagrams

Schematic	Output Configuration	Load	Connection	Wiring Diagrams		
	1a	AC DC	-	V _{IN} I _F V _L (AC,DC) V _{IN} I _F V _L (AC,DC) V _{IN} I _F V _L (AC,DC)		

4PIN 100V N.O TYPE SOLID STATE RELAY-MOSFET OUTPUT

Fig.1 **Load Current** vs. Ambient Temperature

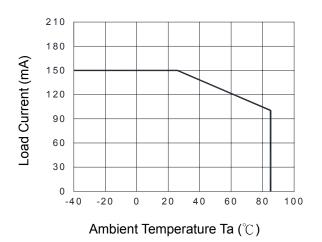
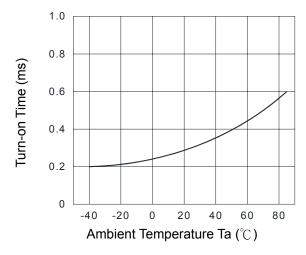
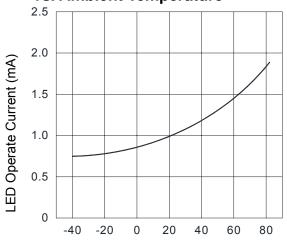


Fig.3 Turn-on Time vs. Ambient Temperature

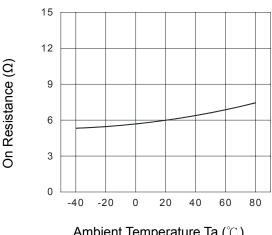


LED Operate Current vs. Ambient Temperature



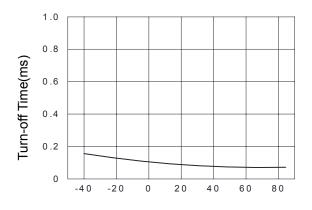
Ambient Temperature Ta (°C)

Fig.2 On Resistance vs. Ambient Temperature



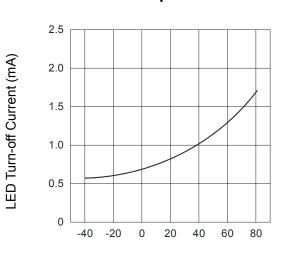
Ambient Temperature Ta (°C)

Fig.4 Turn-off Time vs. Ambient Temperature



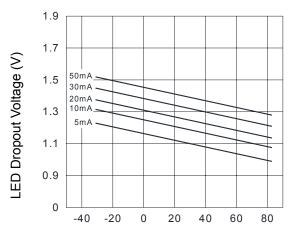
Ambient Temperature Ta (°C)

Fig.6 LED Turn-off Current vs. Ambient Temperature



Ambient Temperature Ta (°C)

Fig.7 LED Dropout Voltage vs. Ambient Temperature



Ambient Temperature Ta (°C)

Fig.9 Turn-on Time vs. LED Forward Current

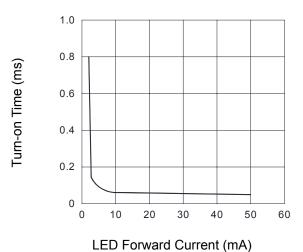


Fig.11 Turn-off Time

vs. LED Forward Current

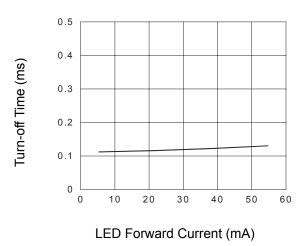
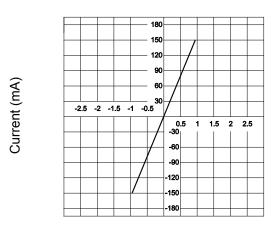
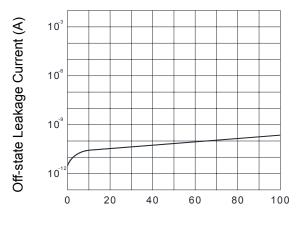


Fig.8 Voltage vs. Current Characteristics of Output at MOSFET Portion



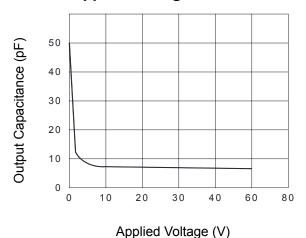
Voltage (V)

Fig.10 Off-state Leakage Current vs. Load Voltage



Load Voltage (V)

Fig.12 Output Capacitance vs. Applied Voltage



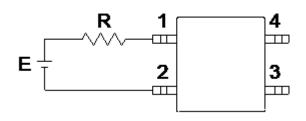
Cosmo Electronics Corp.
Document No. 69M00009.5

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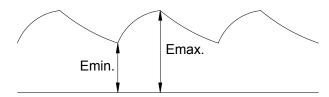
Using Methods

Examples of resistance value to control LED forward current (I_F=2mA)

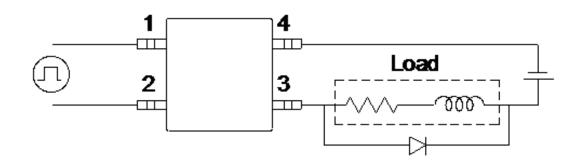


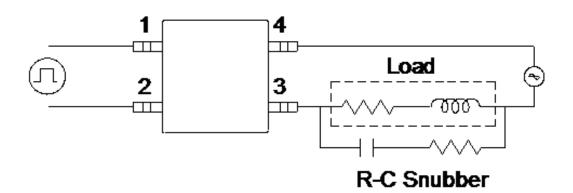
E	R	
3.3V	Approx. 720 Ω	
5V	Approx. 1.5K Ω	
12V	Approx. 4.5K Ω	
15V	Approx. 6.0K Ω	
24V	Approx. 9.5K Ω	

- 1. LED forward current must be more than 2mA, at E min.
- 2. LED forward current must be less than 50mA, at E max.



Regulate the spike voltage generated on the inductive load as follows:







KCP1008 Series 4PIN 100V N.O TYPE SOLID STATE RELAY-MOSFET OUTPUT

Recommended Soldering Conditions

(a) Infrared reflow soldering:

■ Peak reflow soldering : 260°C or below (package surface temperature)

Time of peak reflow temperature : 10 sec
 Time of temperature higher than 230°C : 30-60 sec
 Time to preheat temperature from 180~190°C : 60-120 sec

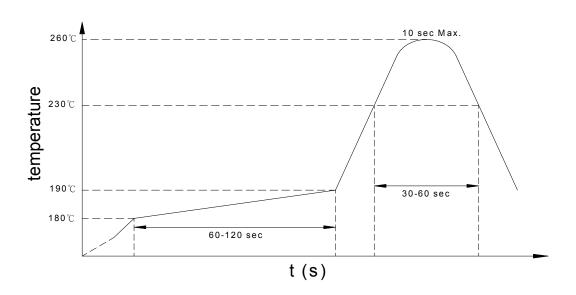
■ Time(s) of reflow: Two

■ Flux : Rosin flux containing small amount of chlorine (The

flux with a maximum chlorine content of 0.2 Wt% is

recommended.)

Recommended Temperature Profile of Infrared Reflow



(b) Wave soldering:

■ Temperature : 260°C or below (molten solder temperature)

■ Time : 10 seconds or less

■ Preheating conditions : 120°C or below (package surface temperature)

■ Time(s) of reflow : One

■ Flux: Rosin flux containing small amount of chlorine (The flux with a maximum

chlorine content of 0.2 Wt% is recommended.)

(c) Cautions:

■ Fluxes : Avoid removing the residual flux with freon-based and chlorine-based

cleaning solvent.

Avoid shorting between portion of frame and leads.



Numbering System

KCP1008 (X)

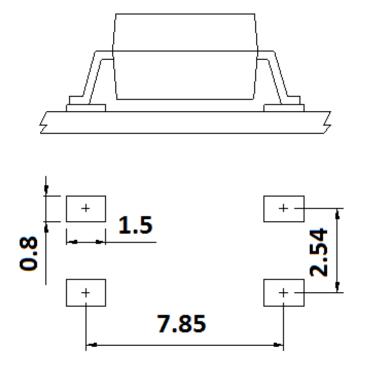
Notes:

KCP1008 = Part No.

 $X = Tape and reel option (TLD \cdot TRU)$

Option	Description	Packing quantity	
TLD	small outline for surface mount type package +	3000 units per reel	
ILD	TLD tape & reel option	3000 driits per reei	
TRU	small outline for surface mount type package +	2000 unito per real	
	TRU tape & reel option	3000 units per reel	

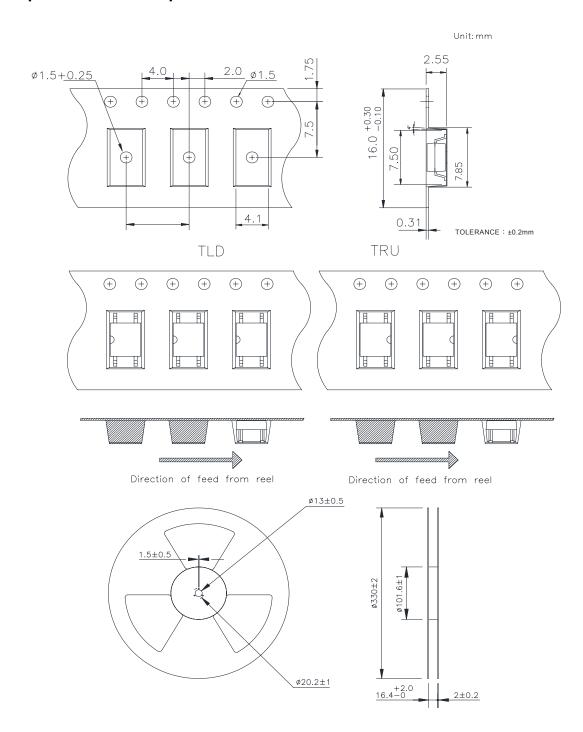
• Recommended Pad Layout for Surface Mount Lead Form



Unit: mm

4PIN 100V N.O TYPE SOLID STATE RELAY-MOSFET OUTPUT

• 4-pin SOP Carrier Tape & Reel





KCP1008 Series 4PIN 100V N.O TYPE SOLID STATE RELAY-MOSFET OUTPUT

Application Notice

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- b. OA machine
- c. Audio / Video
- d. Instrumentation
- e. Electrical application
- f. Measurement equipment
- g. Consumer electronics
- h. Telecommunication

cosmo devices shall not be used or related with equipment requiring higher level of quality / reliability, or malfunction, or failure which may cause loss of human life, bodily injury, includes, without limitation:

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- b. Space application
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- d. Nuclear power control
- e. Equipment used for automotive vehicles, trains, ships...etc.

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